#### Overview

The KEMET Organic Capacitor (KO-CAP) is a tantalum capacitor with a Ta anode and  $Ta_2O_5$  dielectric. A conductive organic polymer replaces the traditionally used  $MnO_2$  as the cathode plate of the capacitor. This results in very low ESR and improved capacitance retention at high frequency. The KO-CAP also exhibits a benign failure mode which eliminates the ignition failures that can occur in standard  $MnO_2$  tantalum types. KO-CAPs may also be operated at steady state voltages up to 90% of rated voltage for part types with rated voltages of ≤10 volts and up to 80% of rated voltage for part types >10 volts with equivalent or better reliability than traditional  $MnO_2$  tantalum capacitors operated at 50% of rated voltage.

The T521 Series High Voltage Polymer Tantalum is designed

### **Benefits**

- · Voltage ratings to 35V
- Volumetric efficiency
- · Stable temperature characteristics
- Up to 68µF capacitance value
- High ripple current capability
- Low ESR
- · High reliability
- Low profile design
- · Benign failure mode
- Pb Free when ordered with 100% Sn termination
- RoHS compliant and Halogen Free

# **Environmental Compliance**

RoHS Compliant (6/6)\* according to Directive 2002/95/EC \*When ordered with 100% Sn Solder

#### SPICE

For a detailed analysis of specific part numbers, please visit kemet.com for a free download of KEMET's SPICE software. The KEMET SPICE program is freeware intended to aid design engineers in analyzing the performance of these capacitors over frequency, temperature, ripple, and DC bias conditions.

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for higher application voltages such as 12V, 24V and 28V input rails. This series demonstrates excellent high voltage handling capabilities and reliability and is commonly selected as a replacement for other high capacitance dielectrics such as  $MnO_2$  tantalum and aluminum electrolytic capacitors. The T521 Series can be safely operated at 80% of the rated voltage and can withstand transient conditions up to the rated voltage of the component. This series offers higher capacitance for a given application voltage when compared to multilayer ceramic and tantalum  $MnO_2$  devices. The T521 Series also offers superior ESR performance over tantalum  $MnO_2$  and aluminum electrolytic capacitors and a much lower profile than aluminum polymer and aluminum electrolytic capacitors.

#### **Applications**

Typical applications include DC/DC converters, power supply input and higher voltage applications such as 12V to 28V power input rails in the military/aerospace and industrial markets.



**One KEMET** 





# **Ordering Information**

Т	521	V	226	Μ	025	Α	Т	E060	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Failure Rate/ Design	Lead Material	ESR Code	Packaging (C-Spec)
T = Tantalum	521 = High Voltage Polymer	D = 7343-31 V = 7343-20 W = 7343-15 X = 7343-43	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	016 = 16V 020 = 20V 025 = 25V 035 = 35V	A = N/A	T = 100% Matte Tin (Sn) Plated H = Tin/Lead (SnPb) Solder Coated (5% Pb minimum)	E = ESR Last three digits specify ESR in mOhms. (060 = 60mOhms)	Blank = 7" Reel 7280 = 13" Reel

# **Performance Characteristics**

ltem	Performance Characteristics
Operating Temperature	-55°C to 105°C/125°C - Refer to Part Number for Max Temp Rating
Rated Capacitance Range	15μF - 68μF @ 120 Hz/25°C
Capacitance Tolerance	M Tolerance (20%)
Rated Voltage Range	16V - 35V
DF(120Hz)	≤ 10%
ESR (100kHz)	Refer to Part Number Electrical Specification Table
Leakage Current	$\leq$ 0.1CV (µA) at Rated Voltage after 5 minutes



# Qualification

Test	Condition			Charact	teristics				
			ΔC/C	Within -20/+7	10% of initial va	alue			
Endurance	105°C @ Rated Voltage, 2000 Hrs.		DF	Within initial limits					
Endurance	125°C @ 2/3 Rated Voltage, 2000 Hrs.**		DCL	IL @ 105° C	IL @ 105° C, 2x IL @ 125° C				
			ESR	2x Initial Lim	it				
			ΔC/C	Within -20/+	10% of initial va	alue			
Storage	105°C @ 0 Volts, 2000 Hrs.		DF	Within initial	limits				
Siorage	125°C @ 0 Voltage, 2000 Hrs.**		DCL	IL @ 105° C, 2x IL @ 125° C					
			ESR	2x Initial Limit					
			∆C/C	Within -5%/+35% of initial value					
Humidity	60° C, 90% RH, 500Hr, Rated Voltage 60° C, 90% RH, 500Hr, No Load	DF	Within initial	limits					
			DCL	Within 3.0 x	initial limit				
			+25°C	-55°C	+85°C	+105/125°C			
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25 C,	ΔC/C	IL*	±20%	±20%	±30%			
	-55C, +25 C, +85 C, +105/125 C, +25 C.	DF	IL	IL	1.2 x IL	1.5 x IL			
		DCL	IL	n/a	10 x IL	10 x IL			
			∆C/C	Within -20/+	10% of initial va	alue			
Surge Voltage	105° C, 1.32 x Rated Voltage, 33Ω Resistance,	1000 avalas	DF	Within initial	limits				
Surge Voltage		TOOD Cycles	DCL	Within initial limits					
			ESR	Within initial limits					
	Mil-Std-202, Meth. 213, Cond. I, 100G Peak		ΔC/C	Within ±10%	of initial value				
Mechanical Shock/Vibration	Mil-Std-202, Meth. 204, Cond. D, 10Hz to 2000	Hz, 20G	DF	Within initial	limits				
	Peak		DCL	Within initial	limits				

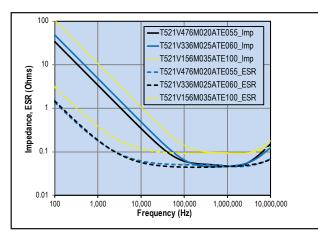
\*IL = Initial Limit

\*\*Refer to part number specifications for individual temperature classification.

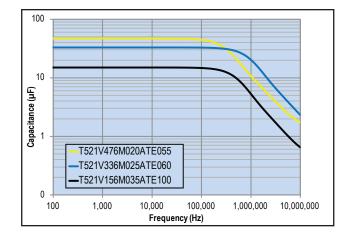


# **Electrical Characteristics**

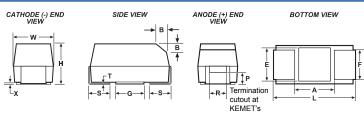
ESR vs. Frequency



Capacitance vs. Frequency



#### Dimensions – Millimeters (Inches) Metric will govern



Option, either end

Case	Size	Component												
KEMET	EIA	L*	W*	H*	F* ±0.1 ±(.004)	S* ±0.3 ±(.012)	B* ±0.15 (Ref) ±.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
D	7343-31	7.3 ± 0.3 (287 ± .012)	4.3 ± 0.3 (.169 ± .012)	$2.8 \pm 0.3$ (098 ± .012)	2.4 (.094)	1.3 (.051)	0.5 (.020)	$0.10 \pm 0.10$ (.004 ± .004)	0.9 (.035)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
V	7343-20	7.3 ± 0.3 (287 ± .012)	4.3 ± 0.3 (.169 ± .012)	1.9 (.075) max	2.4 (.094)	1.3 (.051)	n/a	0.05 (.002)	n/a	n/a	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
W	7343-15	7.3 ± 0.3 (287 ± .012)	4.3 ± 0.3 (.169 ± .012)	1.5 (.059) max	2.4 (.094)	1.3 (.051)	n/a	0.05 (.002)	n/a	n/a	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
Х	7343-43	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	4.0 ± 0.3 (.157 ± .012)	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	1.7 (.067)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)

Notes: (Ref) – Dimensions provided for reference only. No dimensions provided for B, P or R because low profile cases do not have a bevel or a notch. \* MIL-C-55365/8 specified dimensions



Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current	Moisture Sensitivity	Rated Temp
VDC	120Hz	KEMET/EIA	(See below for	+20°C	+20°C 120Hz	+20°C 100kHz	+45°C 100kHz	Temp≤260°C	(°C)
VDC	μF	KEIVIE I/EIA	part options)	μAmps	% Max	mOhms	mAmps	J-STD-020D	(0)
16	68	V/7343-20	T521V686M016A(1)E050	108.8	10	50	1900.0	3	105
16	68	V/7343-20	T521V686M016A(1)E090	108.8	10	90	1400.0	3	105
16	100	D/7343-31	T521D107M016A(1)E050	160.0	10	50	2100.0	3	105
20	47	V/7343-20	T521V476M020A(1)E090	94.0	10	90	1400.0	3	125
20	47	V/7343-20	T521V476M020A(1)E055	94.0	10	55	1800.0	3	125
20	47	D/7343-31	T521D476M020A(1)E055	94.0	10	55	2000.0	3	125
25	22	V/7343-20	T521V226M025A(1)E060	55.0	10	60	1800.0	3	105
25	33	V/7343-20	T521V336M025A(1)E060	82.5	10	60	1800.0	3	105
25	33	D/7343-31	T521D336M025A(1)E060	82.5	10	60	1900.0	3	105
35	15	V/7343-20	T521V156M035A(1)E100	52.5	10	100	1400.0	3	125
35	15	V/7343-20	T521V156M035A(1)E125	52.5	10	125	1200.0	3	125
35	47	X/7343-43	T521X476M035A(1)E030	164.5	10	30	2900.0	3	125
35	47	X/7343-43	T521X476M035A(1)E070	164.5	10	70	1900.0	3	125
VDC	μF		(see below for	μAmps	% Max	mOhms	mAmps	J-STD-020d	(90)
VDC	120Hz	KEMET/EIA	part options)	+20°C	+20°C 120Hz	+20°C 100kHz	+45°C 100kHz	Temp≤260°C	(°C)
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum allowable ripple current	Moisture Sensitivity	Rated Temp

### Table 1 – Ratings & Part Number Reference

Other part number options:

1- Standard with tin terminations (14th character = T). Tin/lead terminations is also available (14th character = H)

Also available on large (13 inch) reels. Add 7280 to the end of the part number.

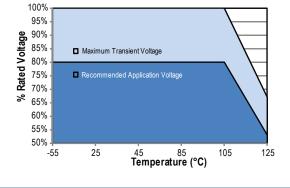
Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitutions will be marked with the higher voltage rating. Substitutions can include better than series.



# **Derating Guidelines**

Voltage Rating	Max Recommended Steady State Voltage	Max Recommended Transient Voltage (1ms - 1µs)					
	-5	5°C to 105°C					
16V ≤ V <sub>r</sub> ≤ 35V	80% of V <sub>r</sub>	V <sub>r</sub>					
	10	105°C to 125°C					
16V ≤ V <sub>r</sub> ≤ 35V	54% of V <sub>r</sub>	67% of V <sub>r</sub>					
V = Rated Voltage							





### **Ripple Current/Ripple Voltage**

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

a. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.

b. The negative peak AC voltage, in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage.

The maximum power dissipation by case size can be determined using the below table. The maximum power dissipation rating stated in the table above must be reduced with increasing environmental operating temperatures. Refer to the below table for temperature compensation requirements.

Case	Code	Maximum Power Dissipation (Pmax) mWatts @ 45°C w/+30°C Rise	Temperature Compenstion Multipliers for Maximum Power Dissipation					
KEMET	EIA		≤45°C	45°C < T ≤ 85°C	85°C < T ≤ 105°C			
T520/525T	3528-12	105	1.00	0.70	0.25			
T520M	3528-15	120	T= Environmental Temperature					
T520A	3216-18	112						
T520/525B	3538-21	127	Using the P	max of the device. the	e maximum allowable rms			
T520U	6032-15	135	Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.					
T520L	3528-19	150						
T520C	6032-28	165	$I(max) = \sqrt{P max/R}$					
T520W	7343-15	180	$E(max) = \sqrt{P max \cdot R}$					
T520V	7343-20	187						
T520/525D	7343-31	225		current (amperes)				
T520Y	7343-40	241		voltage (volts)				
T520X	7343-43	247		num power dissipation(wat	ts)			
T528Z	7343-17	325	R = ESR at sp	ecified frequency (ohms)				
T530D	7343-31	255						
T530Y	7343-40	263						
T530X	7443-43	270						



### **Reverse Voltage**

Polymer tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected in the wrong polarity. These devices will withstand a small degree of transient voltage reversal for short periods as shown in the below table.

Temperature	Permissible Transient Reverse Voltage
25°C	15% of Rated Voltage
55°C	10% of Rated Voltage
85°C	5% of Rated Voltage
105°C	3% of Rated Voltage
125°C*	1% of Rated Voltage

\*For Series Rated to 125°C

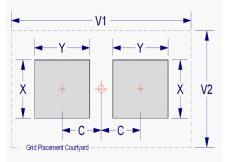
# Table 2 – Land Dimensions/Courtyard

KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)				N	ledian	Density Level B: edian (Nominal) Land Protrusion (mm)				Density Level C: Minimum (Least) Land Protrusion (mm)				
Case	EIA	Х	Y	С	V1	V2	Х	Y	С	V1	V2	Х	Y	С	V1	V2
D	7343-31	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
V	7343-20	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
X1	7343-43	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
W	7343-15	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component desity product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

<sup>1</sup> Height of these chips may create problems in wave soldering.





## **Soldering Process**

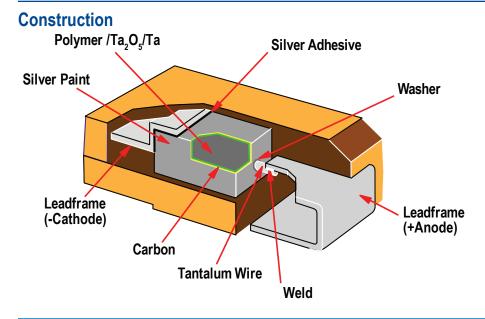
KEMET's families of surface mount tantalum capacitors are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivety testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

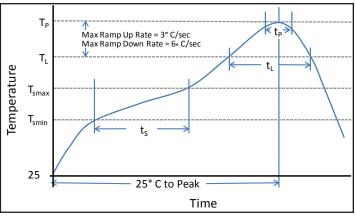
Note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3mm maximum) dictates care in wave process development.

Profile Feature	Sn-Pb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Min (T <sub>Smin</sub> )	100°C	150°C
Temperature Max (T <sub>Smax</sub> )	150°C	200°C
Time (t <sub>s</sub> ) from $T_{min}$ to $T_{max}$ )	60-120 sec	60-120 sec
Ramp-up rate $(T_L to T_p)$	3°C/sec max	3°C/sec max
Liquidous temperature (T <sub>L</sub> )	183°C	217°C
Time above liquidous $(t_{L})$	60-150 sec	60-150 sec
Peak Temperature (T <sub>p</sub> )	220°C* 235°C**	250°C* 260°C**
Time within 5°C of max peak temperature (t <sub>p</sub> )	20 sec max	30 sec max
Ramp-down rate $(T_p \text{ to } T_L)$	6°C/sec max	6°C/sec max
Time 25°C to peak temperature	6 minutes max	8 minutes max

Note 1: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow. \* Case Size D, E, P, Y and X

\*\*Case Size A, B, C, H, I, K, M, R, S, T, U, V, W and Z

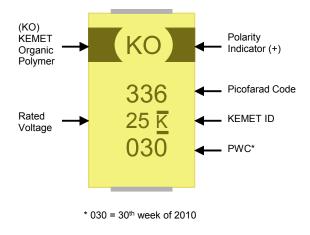




Time/Temperature Soldering Profile



# **Capacitor Marking**



#### Storage

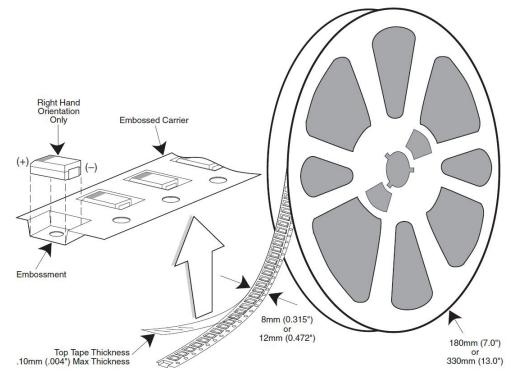
All KO-Cap series are shipped in moisture barrier bags with a desiccant and moisture indicator card. These series are classified as MSL3 (Moisture Sensitivity Level 3).

Product contained within the moisture barrier bags should be stored in normal working environments with temperatures not to exceed 40°C and humidity not in excess of 60% RH.



## Tape & Reel Packaging Information

KEMET's Molded Tantalum and Aluminum Chip Capacitor families are packaged in 8 mm and 12 mm plastic tape on 7" and 13" reels, in accordance with EIA Standard 481-1: Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape fed automatic pick and place systems.



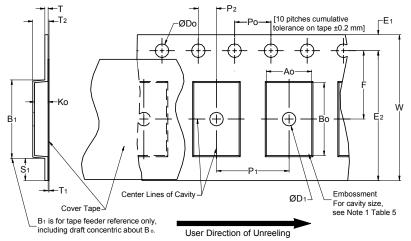
# Table 4 – Packaging Quantity

Case	Code	Tape Width-mm	7" Reel*	13" Reel*
KEMET	EIA			
R	2012-12	8	2,500	10,000
I	3216-10	8	3,000	12,000
S	3216-12	8	2,500	10,000
Т	3528-12	8	2,500	10,000
М	3528-15	8	2,000	8,000
U	6032-15	12	1,000	5,000
L	6032-19	12	1,000	5,000
W	7343-15	12	1,000	3,000
Z	7343-17	12	1,000	3,000
V	7343-20	12	1,000	3,000
A	3216-18	8	2,000	9,000
В	3528-21	8	2,000	8,000
С	6032-28	12	500	3,000
D	7343-31	12	500	2,500
Y	7343-40	12	500	2,000
Х	7343-43	12	500	2,000
E	7260-38	12	500	2,000

\* No c-spec required for 7" reel packaging. C-7280 required for 13" reel packaging.







# Table 5 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

		(	Constant Dime	ensions — Milli	meters (Inche	es)			
Tape Size	D <sub>0</sub>	D <sub>1</sub> Min. Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Ref. Note 2	S₁ Min. Note 3	T Max.	T <sub>1</sub> Max.
8mm		1.0 (0.039)				25.0 (0.984)			
12mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	$1.75 \pm 0.10$ (0.069 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)	2.0 ± 0.05 (0.079 ± 0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16mm		(0.059)				(1.181)			
		,	Variable Dime	nsions — Millin	meters (Inche	s)			
Tape Size	Pitch	B₁ Max. Note 4	E <sub>2</sub> Min.	F	P <sub>1</sub>	T <sub>2</sub> Max	W Max	A <sub>0</sub> ,B	, & K <sub>0</sub>
8mm	Single (4mm)	4.35 (0.171)	6.25 (0.246)	3.5 ± 0.05 (0.138 ± 0.002)	4.0 ± 0.10 (0.157 ± 0.004)	2.5 (0.098)	8.3 (0.327)		
12mm	Single (4mm) & Double (8mm)	8.2 (0.323)	10.25 (0.404)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	12.3 (0.484)	No	te 5
16mm	Triple (12mm)	12.1 (0.476)	14.25 (0.561)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

2. The tape with or without components shall pass around R without damage (see Figure 5).

3. If S<sub>1</sub><1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Document 481 paragraph 4.3 (b)).

4. B1 dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by A<sub>o</sub>, B<sub>o</sub> and K<sub>o</sub> shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12mm tapes and 10° maximum for 16mm tapes (see Figure 3).

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8mm and 12mm wide tape and to 1.0mm maximum for 16mm tape (see Figure 4).

(e) for KPS Series product  $A_0$  and  $B_0$  are measured on a plane 0.3mm above the bottom of the pocket.

(f) see Addendum in EIA Document 481 for standards relating to more precise taping requirements.



# **Packaging Information Performance Notes**

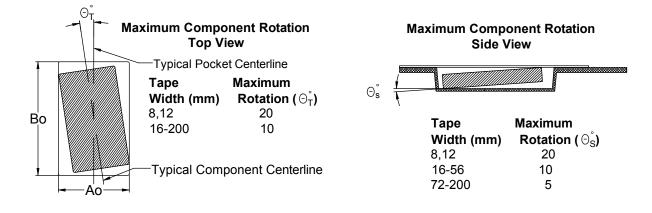
- 1. Cover Tape Break Force: 1.0 Kg Minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8mm	0.1 Newton to 1.0 Newton (10gf to 100gf)
12mm & 16mm	0.1 Newton to 1.3 Newton (10gf to 130gf)

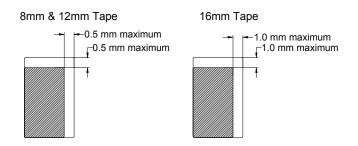
The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA-556 and EIA-624.

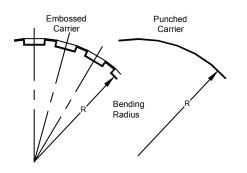
# Figure 3 – Maximum Component Rotation



# Figure 4 – Maximum Lateral Movement

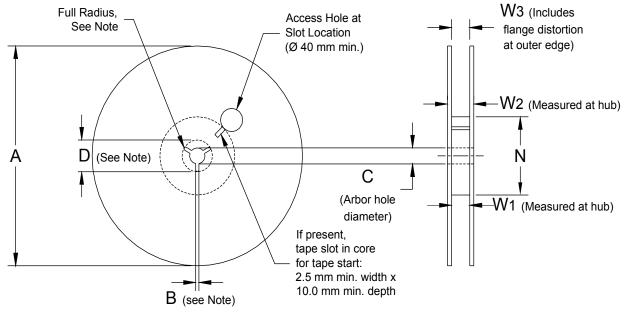


# Figure 5 – Bending Radius





### Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

## Table 7 – Reel Dimensions

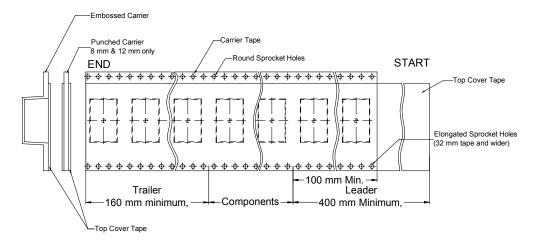
Metric will govern

Constant Dimensions — Millimeters (Inches)				
Tape Size	А	B Min	С	D Min
8mm	$ \begin{array}{c} 178 \pm 0.20 \\ (7.008 \pm 0.008) \\ or \\ 330 \pm 0.20 \\ (13.000 \pm 0.008) \end{array} $			
12mm		1.5	13.0 +0.5/-0.2	20.2
16mm		(0.059)	(0.521 +0.02/-0.008)	(0.795)
	Variable	Dimensions — Millimete	ers (Inches)	
Tape Size	N Min	W <sub>1</sub>	W <sub>2</sub> Max	W <sub>3</sub>
8mm		8.4 +1.5/-0.0	14.4	
Onin		(0.331 +0.059/-0.0)	(0.567)	
12mm	50	12.4 +2.0/-0.0	18.4	Shall accommodate tape widt
1211111	(1.969)	(0.488 +0.078/-0.0)	(0.724)	without interference
16mm		16.4 +2.0/-0.0	22.4	
IVIIIII		(0.646 +0.078/-0.0)	(0.882)	

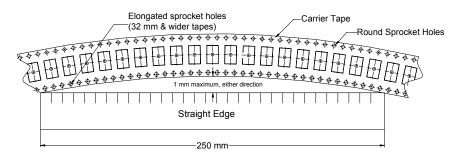
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# Figure 7 – Tape Leader & Trailer Dimensions



# Figure 8 – Maximum Camber



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### **Other KEMET Resources**

Tools	
Resource	Location
Configure A Part: CapEdge	http://capacitoredge.kemet.com
SPICE & FIT Software	http://www.kemet.com/spice
Search Our FAQs: KnowledgeEdge	http://www.kemet.com/keask

Product Information		
Resource	Location	
Products	http://www.kemet.com/products	
Technical Resources (Including Soldering Techniques)	http://www.kemet.com/technicalpapers	
RoHS Statement	http://www.kemet.com/rohs	
Quality Documents	http://www.kemet.com/qualitydocuments	

Product Request	
Resource	Location
Sample Request	http://www.kemet.com/sample
Engineering Kit Request	http://www.kemet.com/kits

Contact	
Resource	Location
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Investor Relations	http://www.kemet.com/ir
Call Us	1-877-MyKEMET
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